Memory analysis for process mypart_obj190, glue part

Acn_Enc_Int_PositiveInteger_ConstSize_big_endian_B	556
Acn_Enc_Int_PositiveInteger_ConstSize_little_endian_16	52
Acn_Enc_Int_PositiveInteger_ConstSize_little_endian_32	52
Acn_Enc_Int_PositiveInteger_ConstSize_little_endian_64	52
Acn_Enc_Int_PositiveInteger_ConstSize_little_endian_N	244
Acn_Enc_Int_PositiveInteger_VarSize_LengthEmbedded	256
Acn_Enc_Int_TwosComplement_ConstSize	312
Acn_Enc_Int_TwosComplement_ConstSize_8	48
Acn_Enc_Int_TwosComplement_ConstSize_big_endian_16	48
Acn_Enc_Int_TwosComplement_ConstSize_big_endian_32	48
Acn_Enc_Int_TwosComplement_ConstSize_big_endian_64	48
Acn_Enc_Int_TwosComplement_ConstSize_little_endian_16	48
Acn_Enc_Int_TwosComplement_ConstSize_little_endian_32	48
Acn_Enc_Int_TwosComplement_ConstSize_little_endian_64	48
Acn_Enc_Int_TwosComplement_VarSize_LengthEmbedded	200
Acn_Enc_Length	56
Acn_Enc_Real_IEEE754_32_big_endian	228
Acn_Enc_Real_IEEE754_32_little_endian	228